## **Slotted Optical Switch**

**OPB855** 



## Features:

- Low profile 0.27" (6.86 mm) overall height
- Printed PCBoard mounting
- 0.205" (5.21 mm) wide and 0.220 (5.59 mm) deep slot
- 0.380" (9.65 mm) lead spacing
- Opaque plastic housing

### **Description:**

The OPB855 slotted optical switch consists of an infrared emitting diode and a NPN silicon phototransistor, mounted on opposite sides of a 0.205" (5.21 mm) wide slot in an inexpensive plastic housing. Switching of the phototransistor occurs whenever an opaque object passes through the slot.

#### **Applications:**

- Non-contact interruptive object sensing
- Assembly line automation
- Machine automation
- Equipment security
- Machine safety



Pin #	Description
1	Anode
2	Cathode
3	Collector
4	Emitter

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General Note

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## **Slotted Optical Switch**

# **Electronics**

## OPB855

## **Electrical Specifications**

### Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Storage & Operating Temperature Range	-40°C to +85° C				
Lead Soldering Temperature [1/16 inch (1.6mm) from the case for 5 sec. with soldering iron] $^{(1)}$	260° C				
nput Diode (See OP140 for additional information)					
Forward DC Current	50 mA				
Peak Forward Current (1 μs pulse width, 300 pps)	1 A				
Reverse DC Voltage	2 V				
Power Dissipation <sup>(2)</sup>	100 mW				
Dutput Phototransistor (See OP550 for additional information)					
Collector-Emitter Voltage	30 V				
Emitter-Collector Voltage	5 V				
Collector DC Current	30 mA				
Power Dissipation <sup>(2)</sup>	100 mW				

#### Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise noted)

MBOL	PARAMETER	MIN	ТҮР	MAX	UNITS	TEST CONDITIONS
ıt Diode	2					
$V_{\rm F}$	Forward Voltage	-	1.30	1.80	V	I <sub>F</sub> = 20 mA
I <sub>R</sub>	Reverse Current	-	-	100	μA	$V_R = 2 V$
put Pho	totransistor			•	•	
		20				
(BR)CEO	Collector-Emitter Breakdown Voltage	30	-	-	V	$I_c = 1 \text{ mA}$
(BR)CEO (BR)ECO	Collector-Emitter Breakdown Voltage Emitter-Collector Breakdown Voltage	5	-	-	v v	I <sub>c</sub> = 1 mA I <sub>E</sub> = 100 μA

V <sub>CE(SAT)</sub>	Collector-Emitter Saturation Voltage	-	-	0.4	V	I <sub>c</sub> = 400 μA, I <sub>F</sub> = 20 mA
I <sub>C(ON)</sub>	On-State Collector Current	1.50	-	20.0	mA	V <sub>CE</sub> = 5 V, I <sub>F</sub> = 20 mA

Notes:

(1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.

(2) Derate linearly 1.67 mW/°C above 25  $^\circ$  C.

(3) Methanol or isopropanol are recommended as cleaning agents. Plastic housing is soluble in chlorinated hydrocarbons and ketones.

(4) All parameters tested using pulse technique.

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**OPB855** 





OPB855 - Flag in Middle of Slot

**Displacement Distance (inches)** 

#### **Test Schematic**



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Revision	Change Description	ECN	Date	Approved
A	Initial Release	XXXXXX		
A.1	Revised to new template. Required changes on all pages.	N/A	11/28/05	
A.2	Update package outline on page 1	N/A	3/11/09	Mark Miller

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